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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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Renesas Technology Corp. Customer Support Dept. April 1, 2003



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Silicon N Channel Power MOS FET High Speed Power Switching

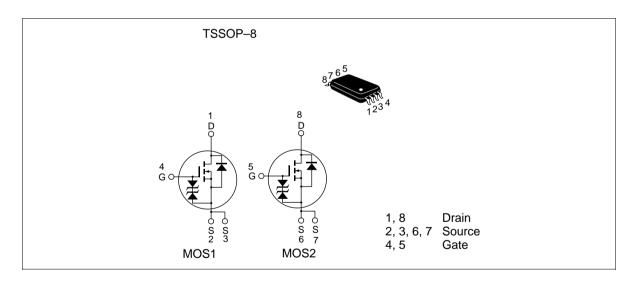


ADE-208-661A (Z) 2nd. Edition Feb. 1999

Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

Outline



Absolute Maximum Ratings $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	$V_{\scriptscriptstyle DSS}$	30	V
Gate to source voltage	$V_{\sf GSS}$	± 10	V
Drain current	I _D	1	A
Drain peak current	Note1	4	A
Body-drain diode reverse drain current	I _{DR}	1	A
Channel dissipation	Pch Note2	0.8	W
Channel dissipation	Pch Note3	1.2	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	- 55 to + 150	°C

Note: 1. PW \leq 10 μ s, duty cycle \leq 1 %

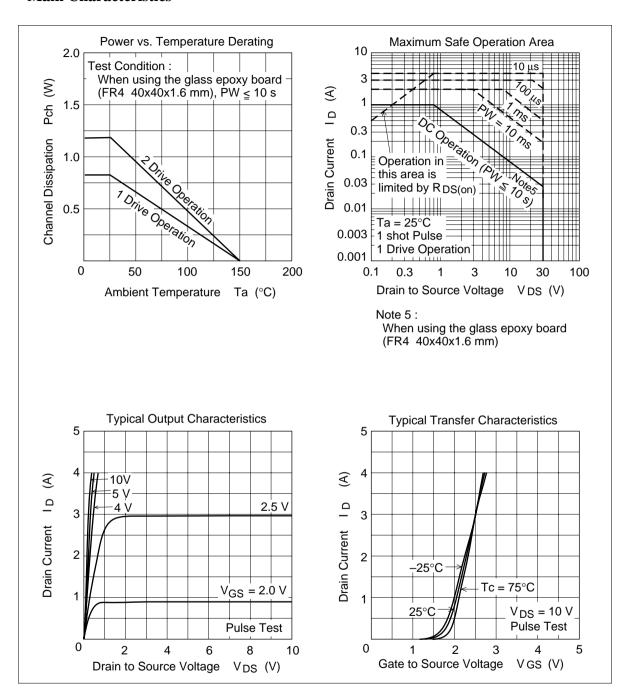
- 2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW \leq 10s
- 3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW≤ 10s

Electrical Characteristics ($Ta = 25^{\circ}C$)

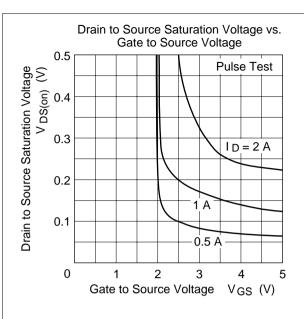
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	30	_	_	V	$I_{D} = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	± 10	_	_	V	$I_{G} = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	± 10	μΑ	$V_{GS} = \pm 8 \text{ V}, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	1	μΑ	$V_{DS} = 30 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	0.75	_	1.75	V	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 1 \text{ mA}$
Static drain to source on state	$R_{\scriptscriptstyle DS(on)}$	_	0.14	0.2	Ω	$I_D = 0.5 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	0.2	0.3	Ω	$I_D = 0.5 \text{ A}, V_{GS} = 4 \text{ V}^{\text{Note4}}$
Forward transfer admittance	y _{fs}	1.4	2.2	_	S	$I_{\rm D} = 0.5 \text{ A}, V_{\rm DS} = 10 \text{ V}^{\rm Note4}$
Input capacitance	Ciss	_	155	_	pF	V _{DS} = 10 V
Output capacitance	Coss	_	75	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	35	_	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	_	12	_	ns	$V_{GS} = 4 \text{ V}, I_{D} = 0.5 \text{ A}$
Rise time	t _r	_	30	_	ns	$V_{DD} \cong 10 \text{ V}$
Turn-off delay time	t _{d(off)}	_	35	_	ns	
Fall time	t _f	_	25	_	ns	
Body-drain diode forward voltage	V_{DF}	_	0.81	1.1	V	$I_F = 1 A$, $V_{GS} = 0$ Note4
Body-drain diode reverse recovery time	t _{rr}	_	35	_	ns	$I_F = 1 \text{ A}, V_{GS} = 0$ diF/ dt = 20 A/ μ s

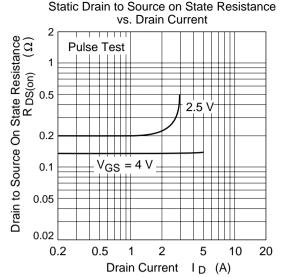
Note: 4. Pulse test

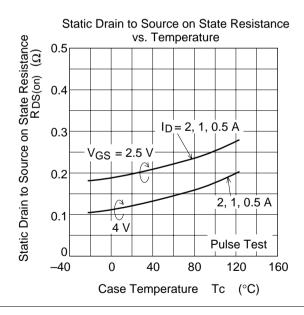
Main Characteristics

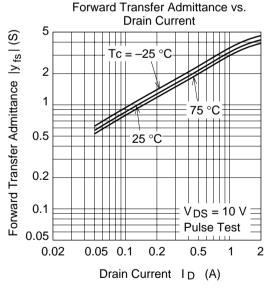


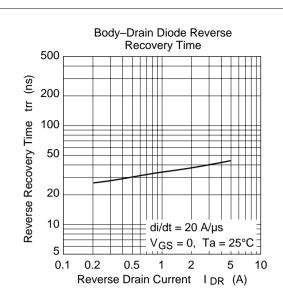
2

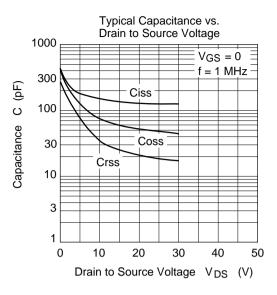


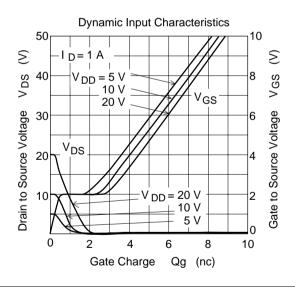


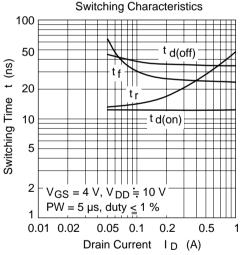


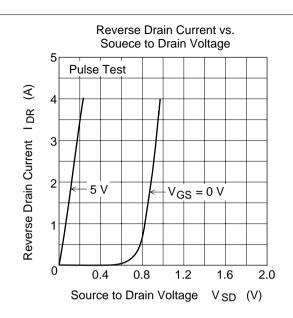


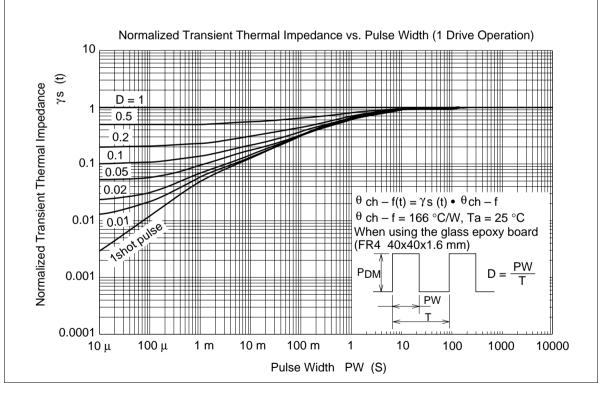


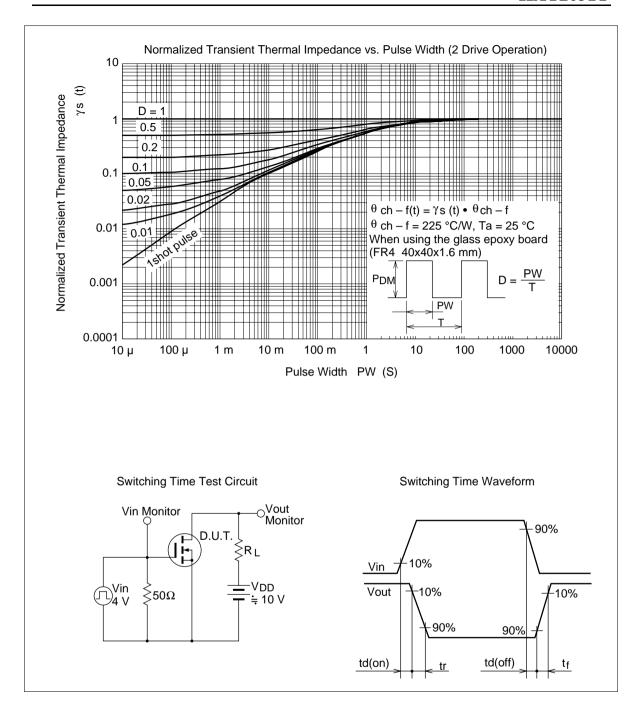




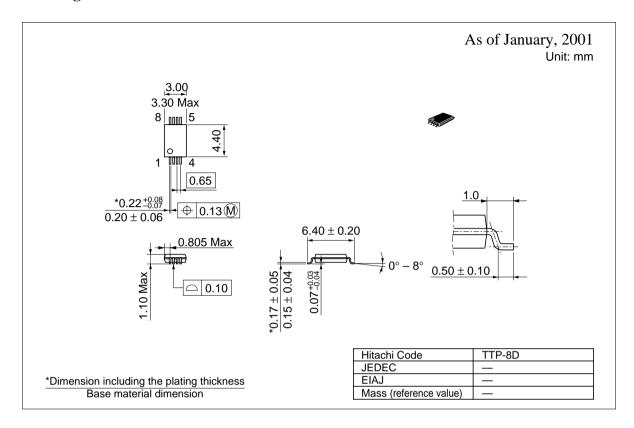








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